



MCP

KMGD6001BM-B421



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Align your design vision with MCP

By expertly combining mobile DRAM and NAND in a compact package, Samsung developed a full MCP lineup for cutting-edge performance and design

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Samsung previews next-generation memory solutions

Samsung proposed next-generation memory technologies and solutions for new business possibilities at Tech Day 2019.

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Samsung expands memory leadership with industry-first

Samsung is offering incorporating its top-of-the-line memory innovations into mid-range devices as well.

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